Hisashi Yamada

List of Publications by Year
in descending order

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96	1,705	257450 24	345221 36
papers	citations	h-index	g-index

97	97	97	1379
all docs	docs citations	times ranked	citing authors

#	Article	IF	Citations
1	High Brightness Blue InGaN/GaN Light Emitting Diode on Nonpolarm-plane Bulk GaN Substrate. Japanese Journal of Applied Physics, 2007, 46, L960-L962.	1.5	89
2	Continuous-wave Operation of AlGaN-cladding-free Nonpolar m-Plane InGaN/GaN Laser Diodes. Japanese Journal of Applied Physics, 2007, 46, L761.	1.5	83
3	Thin Body IIIâ€“V-Semiconductor-on-Insulator Metalâ€“Oxideâ€“Semiconductor Field-Effect Transistors on Si Fabricated Using Direct Wafer Bonding. Applied Physics Express, 2009, 2, 124501.	2.4	77
4	III-V-semiconductor-on-insulator n-channel metal-insulator-semiconductor field-effect transistors with buried Al2O3 layers and sulfur passivation: Reduction in carrier scattering at the bottom interface. Applied Physics Letters, 2010, 96, 142106.	3.3	64
5	High mobility CMOS technologies using IIIâ€“V/Ge channels on Si platform. Solid-State Electronics, 2013, 88, 2-8.	1.4	64
6	Sub-10-nm Extremely Thin Body InGaAs-on-Insulator MOSFETs on Si Wafers With Ultrathin $hbox{Al}_{2}hbox{O}_{3}$ Buried Oxide Layers. IEEE Electron Device Letters, 2011, 32, 1218-1220.	3.9	60
7	Optical polarization characteristics ofm-oriented InGaN/GaN light-emitting diodes with various indium compositions in single-quantum-well structure. Journal Physics D: Applied Physics, 2008, 41, 225104.	2.8	57
8	Compositional Dependence of Nonpolarm-Plane In_xGa_{1-x}N/GaN Light Emitting Diodes. Applied Physics Express, 0, 1, 041101.	2.4	53
9	Self-Aligned Metal Source/Drain In_xGa_{1-x}As n-Metalâ€“Oxideâ€“Semiconductor Field-Effect Transistors Using Niâ€“InGaAs Alloy. Applied Physics Express, 2011, 4, 024201.	2.4	53
10	Impact of Substrate Miscut on the Characteristic ofm-plane InGaN/GaN Light Emitting Diodes. Japanese Journal of Applied Physics, 2007, 46, L1117-L1119.	1.5	52
11	High Electron Mobility Metalâ€“Insulatorâ€“Semiconductor Field-Effect Transistors Fabricated on (111)-Oriented InGaAs Channels. Applied Physics Express, 2009, 2, 121101.	2.4	49
12	Formation of IIIâ€“V-on-insulator structures on Si by direct wafer bonding. Semiconductor Science and Technology, 2013, 28, 094009.	2.0	47
13	Comparison of InGaN/GaN light emitting diodes grown on m â€plane and a â€plane bulk GaN substrates. Physica Status Solidi - Rapid Research Letters, 2008, 2, 89-91.	2.4	46
14	Reduction in interface state density of Al2O3/InGaAs metal-oxide-semiconductor interfaces by InGaAs surface nitridation. Journal of Applied Physics, 2012, 112, 073702.	2.5	41
15	Effects of piezoelectric fields on optoelectronic properties of InGaN/GaN quantum-well light-emitting diodes prepared on nonpolar (1â€‰0â€‰ ar1 â€‰0) and semipolar (1â€‰1â€‰ ar{2} â€‰2) orientations. Journal Physics D: Applied Physics, 2009, 42, 135106.	2.8	40
16	Well-width dependence of optical properties of rare-earth ion-dopedZnS0.8Se0.2/undopedZnS multiple quantum wells. Physical Review B, 2003, 67, .	3.2	38
17	Control of Ga-oxide interlayer growth and Ga diffusion in SiO₂/GaN stacks for high-quality GaN-based metalâ€“oxideâ€“semiconductor devices with improved gate dielectric reliability. Applied Physics Express, 2018, 11, 015701.	2.4	35
18	Optical polarization characteristics of InGaNâˆ•GaN light-emitting diodes fabricated on GaN substrates oriented between (101Â¯) and (101Â¯1Â¯) planes. Applied Physics Letters, 2008, 92, .	3.3	34

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19	Extremely-thin-body InGaAs-on-insulator MOSFETs on Si fabricated by direct wafer bonding. , 2010, , .		33
20	Impact of InGaAs surface nitridation on interface properties of InGaAs metal-oxide-semiconductor capacitors using electron cyclotron resonance plasma sputtering SiO2. Applied Physics Letters, 2010, 97, 132102.	3.3	29
21	High Performance Extremely Thin Body InGaAs-on-Insulator Metalâ€“Oxideâ€“Semiconductor Field-Effect Transistors on Si Substrates with Niâ€“InGaAs Metal Source/Drain. Applied Physics Express, 2011, 4, 114201.	2.4	28
22	Experimental Study on Electron Mobility in In_xGa_{1-x}As-on-Insulator Metal-Oxide-Semiconductor Field-Effect Transistors With In Content Modulation and MOS Interface Buffer Engineering. IEEE Nanotechnology Magazine, 2013, 12, 621-628.	2.0	28
23	IIIâ€“V/Ge High Mobility Channel Integration of InGaAs n-Channel and Ge p-Channel Metalâ€“Oxideâ€“Semiconductor Field-Effect Transistors with Self-Aligned Ni-Based Metal Source/Drain Using Direct Wafer Bonding. Applied Physics Express, 2012, 5, 076501.	2.4	26
24	Electron Mobility Enhancement of Extremely Thin Body In$_{0.7}$Ga$_{0.3}$As-on-Insulator Metalâ€“Oxideâ€“Semiconductor Field-Effect Transistors on Si Substrates by Metalâ€“Oxideâ€“Semiconductor Interface Buffer Layers. Applied Physics Express, 2012, 5, 014201.	2.4	26
25	Optical polarization of m â€plane Inâ€GaN/GaN lightâ€emitting diodes characterized via confocal microscope. Physica Status Solidi (A) Applications and Materials Science, 2008, 205, 1203-1206.	1.8	25
26	Effects of off-axis GaN substrates on optical properties of m-plane InGaN/GaN light-emitting diodes. Journal of Crystal Growth, 2008, 310, 4968-4971.	1.5	25
27	Nonâ€polarâ€oriented InGaN lightâ€emitting diodes for liquidâ€crystalâ€display backlighting. Journal of the Society for Information Display, 2008, 16, 571-578.	2.1	25
28	Controlled oxide interlayer for improving reliability of SiO₂/GaN MOS devices. Japanese Journal of Applied Physics, 2019, 58, SCCD06.	1.5	22
29	Self-aligned metal source/drain InP n-metal-oxide-semiconductor field-effect transistors using Niâ€“InP metallic alloy. Applied Physics Letters, 2011, 98, 243501.	3.3	21
30	Enhancement mechanism of terahertz radiation from coherent longitudinal optical phonons in undoped GaAs/n-type GaAs epitaxial structures. Journal of Applied Physics, 2013, 113, .	2.5	21
31	Ultrathin Body InGaAs-on-Insulator Metalâ€“Oxideâ€“Semiconductor Field-Effect Transistors with InP Passivation Layers on Si Substrates Fabricated by Direct Wafer Bonding. Applied Physics Express, 2011, 4, 054202.	2.4	20
32	Front-gate InGaAs-on-Insulator metal-insulator-semiconductor field-effect transistors. Applied Physics Letters, 2010, 97, 253502.	3.3	18
33	Initial Processes of Atomic Layer Deposition of Al2O3 on InGaAs: Interface Formation Mechanisms and Impact on Metal-Insulator-Semiconductor Device Performance. Materials, 2012, 5, 404-414.	2.9	18
34	Impact of La2O3 interfacial layers on InGaAs metal-oxide-semiconductor interface properties in Al2O3/La2O3/InGaAs gate stacks deposited by atomic-layer-deposition. Journal of Applied Physics, 2015, 118, .	2.5	17
35	AC response analysis of Câ€“V curves and quantitative analysis of conductance curves in Al2O3/InP interfaces. Microelectronic Engineering, 2011, 88, 1087-1090.	2.4	16
36	Self-aligned metal source/drain In<inf>x</inf>Ga<inf>1−x</inf>As n-MOSFETs using Ni-InGaAs alloy. , 2010, , .		15

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37	Electrical properties of Ni/n-GaN Schottky diodes on freestandingm-plane GaN substrates. Applied Physics Express, 2017, 10, 041001.	2.4	15
38	Impact of substrate off-angle on them-plane GaN Schottky diodes. Japanese Journal of Applied Physics, 2018, 57, 04FG01.	1.5	14
39	High thermal stability of abrupt SiO₂/GaN interface with low interface state density. Japanese Journal of Applied Physics, 2018, 57, 04FG11.	1.5	14
40	Detection of edge component of threading dislocations in GaN by Raman spectroscopy. Applied Physics Express, 2018, 11, 061002.	2.4	13
41	Deep-level traps in lightly Si-doped n-GaN on free-standing m-oriented GaN substrates. AIP Advances, 2018, 8, .	1.3	12
42	Nondestructive visualization of threading dislocations in GaN by micro raman mapping. Japanese Journal of Applied Physics, 2019, 58, SCCB06.	1.5	12
43	Determination of edge-component Burgers vector of threading dislocations in GaN crystal by using Raman mapping. Applied Physics Express, 2018, 11, 111001.	2.4	11
44	Chemical Vapor Deposition Growth of BN Thin Films Using B₂H₆ and NH₃. Physica Status Solidi (B): Basic Research, 2020, 257, 1900318.	1.5	11
45	Correlation between channel mobility improvements and negative V<inf>th</inf> shifts in III–V MISFETs: Dipole fluctuation as new scattering mechanism. , 2010, , .		10
46	Thin metal intracavity contact and lateral current-distribution scheme for GaN-based vertical-cavity lasers. Applied Physics Letters, 2007, 90, 181128.	3.3	9
47	Recent progress in nonpolar LEDs as polarized light emitters. Physica Status Solidi (A) Applications and Materials Science, 2009, 206, 203-205.	1.8	9
48	Origin of electron mobility enhancement in (1 1 1)-oriented InGaAs channel metalâ€“insulatorâ€“semiconductor field-effect-transistors. Microelectronic Engineering, 2011, 88, 3459-3461.	2.4	9
49	Comparison of Electrical Properties of Ni/nâ€GaN Schottky Diodes on câ€Plane and mâ€Plane GaN Substrates. Physica Status Solidi (A) Applications and Materials Science, 2018, 215, 1700362.	1.8	9
50	Fabrication and Evaluation of N-Channel GaN Metalâ€“Oxideâ€“Semiconductor Field-Effect Transistors Based on Regrown and Implantation Methods. Materials, 2020, 13, 899.	2.9	9
51	Influence of V/III Ratio of Carbon-Doped p-GaAs on Current Gain and Its Thermal Stability in InGaP/GaAs Heterojunction Bipolar Transistors. Japanese Journal of Applied Physics, 2006, 45, 3909-3912.	1.5	8
52	High Quality Thin Body III-V-On-Insulator Channel Layer Transfer on Si Wafer Using Direct Wafer Bonding. ECS Transactions, 2010, 33, 391-401.	0.5	8
53	Comparative Study of Boron Precursors for Chemical Vaporâ€Phase Depositionâ€Grown Hexagonal Boron Nitride Thin Films. Physica Status Solidi (A) Applications and Materials Science, 2021, 218, 2000241.	1.8	8
54	Gold particles containing plasma-polymerized styrene as an X-ray absorber. Plasma Chemistry and Plasma Processing, 1987, 7, 155-167.	2.4	7

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55	The optical excitation mechanism in ZnS: Sm3+ grown by molecular-beam epitaxy. Solid State Communications, 2007, 142, 36-40.	1.9	7
56	Experimental Demonstration of n- and p-channel GaN-MOSFETs toward Power IC Applications. ECS Journal of Solid State Science and Technology, 2020, 9, 015001.	1.8	7
57	Efficient luminescence from Sm-doped ZnSSe/undoped-ZnS multi-quantum wells. Journal of Crystal Growth, 2000, 214-215, 935-938.	1.5	6
58	Characteristics of ultrafast optical responses originating from non-equilibrium carrier transport in undoped GaAs/n-type GaAs epitaxial structures. Journal of Applied Physics, 2013, 113, .	2.5	6
59	Dielectric functions of CVDâ€“grown boron nitride from 1.1 to 9.0 eV by spectroscopic ellipsometry. Applied Physics Letters, 2021, 118, 112101.	3.3	6
60	Compensation centers in ZnSeTe. Journal of Applied Physics, 1999, 86, 5993-5999.	2.5	5
61	High current gain stability of carbon-doped p-GaAs in InGaP/GaAs heterojunction bipolar transistors. Journal of Crystal Growth, 2007, 298, 857-860.	1.5	5
62	Evaluation of GaN substrates grown in supercritical basic ammonia. Applied Physics Letters, 2009, 94, 052109.	3.3	5
63	Frequency Shift of Terahertz Electromagnetic Waves Originating from Sub-Picosecond-Range Carrier Transport in Undoped GaAs/n-Type GaAs Epitaxial Layer Structures. Japanese Journal of Applied Physics, 2010, 49, 082001.	1.5	5
64	Ultrafast optical response originating from carrier-transport processes in undoped GaAs/n-type GaAs epitaxial structures. Applied Physics Letters, 2012, 100, 211902.	3.3	5
65	Energy band structure and electrical properties of Ga-oxide/GaN interface formed by remote oxygen plasma. Japanese Journal of Applied Physics, 2018, 57, 06KA05.	1.5	5
66	Generation of dislocations from scratches on GaN formed during wafer fabrication and dislocation reactions during homoepitaxial growth. Japanese Journal of Applied Physics, 2021, 60, 115501.	1.5	5
67	Sulfur cleaning for (100), (111)A, and (111)B InGaAs surfaces with In content of 0.53 and 0.70 and their Al<inf>2</inf>O<inf>3</inf>/InGaAs MOS interface properties. , 2012, , .		4
68	Growth Temperature Effects of Chemical Vapor Depositionâ€Grown Boron Nitride Layer Using B₂H₆ and NH₃. Physica Status Solidi (B): Basic Research, 2020, 257, 1900521.	1.5	4
69	Behavior of Threading Dislocations from GaN Substrate to Epitaxial Layer. Physica Status Solidi (B): Basic Research, 2020, 257, 1900527.	1.5	4
70	Impact of gate electrode formation process on Al2O3/GaN interface properties and channel mobility. Applied Physics Express, 2021, 14, 081001.	2.4	4
71	High mobility III–V-on-insulator MOSFETs on Si with ALD-Al<inf>2</inf>O<inf>3</inf> BOX layers. , 2010, , .		3
72	Low-temperature formation of Ga-oxide/GaN interface with remote oxygen plasma and its interface properties. Japanese Journal of Applied Physics, 2018, 57, 06JE01.	1.5	3

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73	Interface properties of SiO₂/GaN structures formed by chemical vapor deposition with remote oxygen plasma mixed with Ar or He. Japanese Journal of Applied Physics, 2018, 57, 06KA01.	1.5	3
74	Fabrication of submicron active-region-buried GaN hexagonal frustum structures by selective area growth for directional micro-LEDs. Journal of Crystal Growth, 2019, 507, 437-441.	1.5	3
75	Quenching mechanism of luminescence in Sm-doped ZnS. Journal of Crystal Growth, 2000, 214-215, 954-957.	1.5	2
76	The Effect of n-GaAs Carrier Concentration on Current Gain in InGaP/GaAs Heterojunction Bipolar Transistors. Japanese Journal of Applied Physics, 2007, 46, 5122-5124.	1.5	2
77	Relationships between Interface Structures and Electrical Properties in the High-k/IIIâ€“V System. Materials Research Society Symposia Proceedings, 2009, 1194, 68.	0.1	2
78	III-V-semiconductor-on-insulator MISFETs on Si with buried SiO<inf>2</inf> and Al<inf>2</inf>O<inf>3</inf> layers by direct wafer bonding. , 2010, , .		2
79	Simple strategy for enhancing terahertz emission from coherent longitudinal optical phonons using undoped GaAs/n -type GaAs epitaxial layer structures. Physica Status Solidi C: Current Topics in Solid State Physics, 2011, 8, 343-345.	0.8	2
80	On the mechanisms limiting mobility in InP/InGaAs buried channel nMISFETs. Microelectronic Engineering, 2011, 88, 1076-1078.	2.4	2
81	Controlling Anion Composition at Metalâ€“Insulatorâ€“Semiconductor Interfaces on IIIâ€“V Channels by Plasma Processing. Japanese Journal of Applied Physics, 2012, 51, 065701.	1.5	2
82	Impact of remote plasma oxidation of a GaN surface on photoluminescence properties. Japanese Journal of Applied Physics, 2019, 58, SEEC02.	1.5	2
83	Ferroelectrics field modulation imaging: A useful technique for domain and domain-wall observations. Ferroelectrics, 2020, 556, 37-43.	0.6	2
84	Controlling Anion Composition at Metalâ€“Insulatorâ€“Semiconductor Interfaces on IIIâ€“V Channels by Plasma Processing. Japanese Journal of Applied Physics, 2012, 51, 065701.	1.5	2
85	Fabrication and analysis of InAlN/GaN metalâ€“insulatorâ€“semiconductor high-electron-mobility transistors based on AlN/GaN superlattice channel. Applied Physics Letters, 2021, 119, .	3.3	2
86	Si-related defects in InGaP/GaAs heterojunction bipolar transistors. Physica B: Condensed Matter, 2007, 401-402, 44-47.	2.7	1
87	Hydrogen-related defects in InGaP/GaAs heterojunction bipolar transistors. Journal of Crystal Growth, 2008, 310, 5223-5226.	1.5	1
88	Customized Filter Cube in Fluorescence Microscope Measurements of InGaN/GaN Quantum-Well Characterization. Japanese Journal of Applied Physics, 2009, 48, 098003.	1.5	1
89	(Invited) III-V-On-Insulator MOSFETs on Si Substrates Fabricated by Direct Bonding Technique. ECS Transactions, 2010, 33, 359-370.	0.5	1
90	Analysis of dislocation line tilt in GaN single crystal by Raman spectroscopy. Japanese Journal of Applied Physics, 2021, 60, SAAD03.	1.5	1

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91	Frequency-tunable terahertz electromagnetic wave emitters based on undoped GaAs/n-type GaAs epitaxial layer structures utilizing sub-picosecond-range carrier-transport processes. Journal of Luminescence, 2011, 131, 531-534.	3.1	0
92	Time Evolution of Terahertz Electromagnetic Waves from Undoped GaAs/n-type GaAs Epitaxial Layer Structures Clarified with Use of a Time-Partitioning Fourier Transform Method. Physics Procedia, 2012, 29, 30-35.	1.2	0
93	Formation and reduction of pyramidal hillocks on InGaAs/InP(111)A. Physica Status Solidi (B): Basic Research, 2016, 253, 644-647.	1.5	0
94	Carrier conduction in SiO<inf>2</inf>/GaN structure with abrupt interface. , 2018, , .		0
95	Comparative study of photoluminescence properties obtained from SiO2/GaN and Al2O3/GaN structures. Japanese Journal of Applied Physics, 2019, 58, SIIB22.	1.5	0
96	Reduction in residual impurities in semi-polar <mml:math xmlns:mml="http://www.w3.org/1998/Math/MathML" altimg="si1.gif" overflow="scroll"><mml:mfenced open="(" close=")"><mml:mrow><mml:mn>3</mml:mn><mml:mspace width="5.0pt" /><mml:mn>0</mml:mn><mml:mspace width="5.0pt" /><mml:mover><mml:mn>3</mml:mn><mml:mo>Â¯</mml:mo></mml:mover><mml:mspace width="5.0pt" /><mml:mover><mml:mn>1</mml:mn><mml:mo>Â¯</mml:mo></mml:mover></mml:mrow></mml:mfenced></mml:math>	1.5	0